



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# TECHNICAL DATA SHEET

## SWITCHING DIODE

- METALLURGICALLY BONDED
- HERMETICALLY SEALED
- DOUBLE PLUG CONSTRUCTION

*Qualified per MIL-PRF-19500/241*

## DEVICES

1N3595UR-1

LL3595

MLL3595

## LEVELS

JAN  
JANTX  
JANTXV

## MAXIMUM RATING AT 25°C

Operating Temperature:	-65°C to +175°C
Storage Temperature:	-65°C to +175°C
Surge Current A, sine 1S:	500mA
Surge Current A, sine 1μS:	4A
Total Power Dissipation:	500mW
Operating Current:	150mA, T <sub>A</sub> = +25°C
D.C. Reverse Voltage (VRWM):	125V



## DC ELECTRICAL CHARACTERISTICS

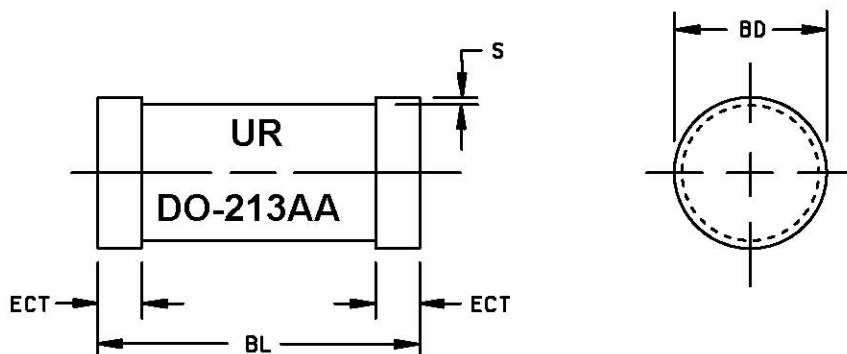
V <sub>F</sub>				I <sub>R</sub>				V <sub>BR</sub>			
Ambient (°C)	I <sub>F</sub> mA	Min V	Max V	Ambient (°C)	V <sub>R</sub> V (dc)	Min μA	Max μA	Ambient (°C)	I <sub>R</sub> μA	Min V	Max V
25	1	0.52	0.70	25	125	-	0.001	-55	100	150	-
25	5	0.60	0.765	150	125	-	3				
25	10	0.65	0.80								
25	50	0.74	0.88								
25	100	0.79	0.92								
25	200	0.83	1.00								

DO-213AA

## AC ELECTRICAL CHARACTERISTICS AT 25°C

	Min	Max	Unit
Capacitance @ 0V	-	8.0	pF
T <sub>RR</sub> @ I <sub>F</sub> = 10mA V <sub>R</sub> = 35V	-	3.0	μsec

## PACKAGE DIMENSIONS



### NOTE:

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. Dimensions are pre-solder dip.
4. Referencing to dimension S, minimum clearance of glass body to mounting surface on all orientations.
5. In accordance with ASME Y14.5M, diameters are equivalent to  $\phi x$  symbology.

Ltr	Dimensions				Notes
	Inches		Millimeters		
	Min	Max	Min	Max	
BD	.063	.067	1.60	1.70	
BL	.130	.146	3.30	3.70	
ECT	.016	.022	0.41	0.55	
S	.001 Min		0.03 Min		

### DESIGN DATA

**Case:** Hermetically sealed glass package per MIL-PRF-19500/241 DO-213AA outline

**Lead Material:** Copper clad steel

**Lead Finish:** Tin / Lead

**Thermal Impedance ( $Z_{\theta JX}$ ):** 70°C/W maximum

**Polarity:** Cathode end is banded

**FIGURE 1. Physical dimensions - 1N3595UR-1, 1N3595AUR-1 (DO-213AA)**